

CDMA/FM LOW NOISE AMPLIFIER/MIXER 900 MHz DOWNCONVERTER

Typical Applications

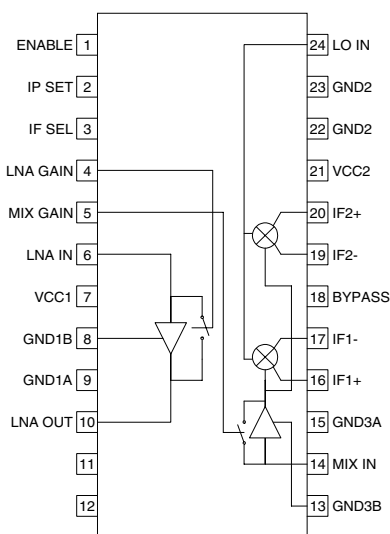
- CDMA/FM Cellular Systems
- Supports Dual-Mode CDMA/AMPS
- Supports Dual-Mode CDMA/TACS
- General Purpose Downconverter
- Commercial and Consumer Systems
- Portable Battery Powered Equipment

Product Description

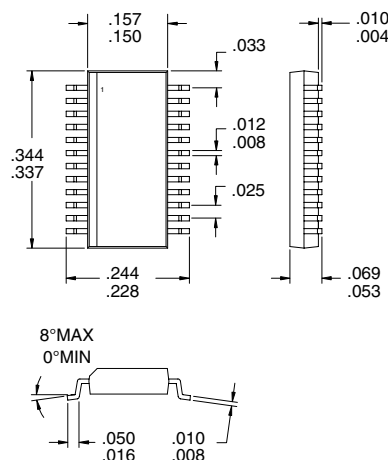
The RF2449 is a receiver front-end designed for the receive section of dual-mode CDMA/FM cellular applications. It is designed to amplify and down-convert RF signals, while providing 30dB of stepped gain control range. Features include digital control of LNA gain, mixer gain, LNA IIP3, and power down mode. Another feature of the chip is adjustable IIP3 of the LNA and mixer using an off-chip current setting resistor. The LNA IIP3 can be digitally controlled between two levels to reduce current draw in CDMA standby and other conditions where high IIP3 is not required. Noise Figure, IP3, and other specs are designed to be compatible with the IS-98 specification for CDMA cellular communications. The IC is manufactured on an advanced Silicon Bipolar process and packaged in an SSOP-24.

Optimum Technology Matching® Applied

- | | | |
|--|-----------------------------------|--------------------------------------|
| <input type="checkbox"/> Si BJT | <input type="checkbox"/> GaAs HBT | <input type="checkbox"/> GaAs MESFET |
| <input checked="" type="checkbox"/> Si Bi-CMOS | <input type="checkbox"/> SiGe HBT | <input type="checkbox"/> Si CMOS |



Functional Block Diagram



Package Style: SSOP-24

Features

- Complete Receiver Front-End
- Stepped LNA/Mixer Gain Control
- Adjustable LNA/Mixer Bias Current
- Adjustable LNA/Mixer IIP3
- Digital LNA IIP3 Control
- Meets IS-98 IMD and Single Tone

Ordering Information

RF2449	CDMA/FM Low Noise Amplifier/Mixer 900MHz Downconverter
RF2449 PCBA	Fully Assembled Evaluation Board

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Absolute Maximum Ratings

Parameter	Rating	Unit
Supply Voltage	-0.5 to +5.0	V _{DC}
Input LO and RF Levels	+6	dBm
Operating Ambient Temperature	-40 to +85	°C
Storage Temperature	-40 to +150	°C






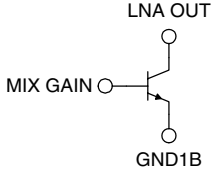
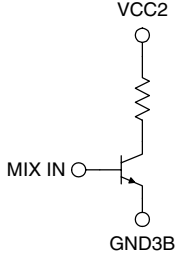


Caution! ESD sensitive device.

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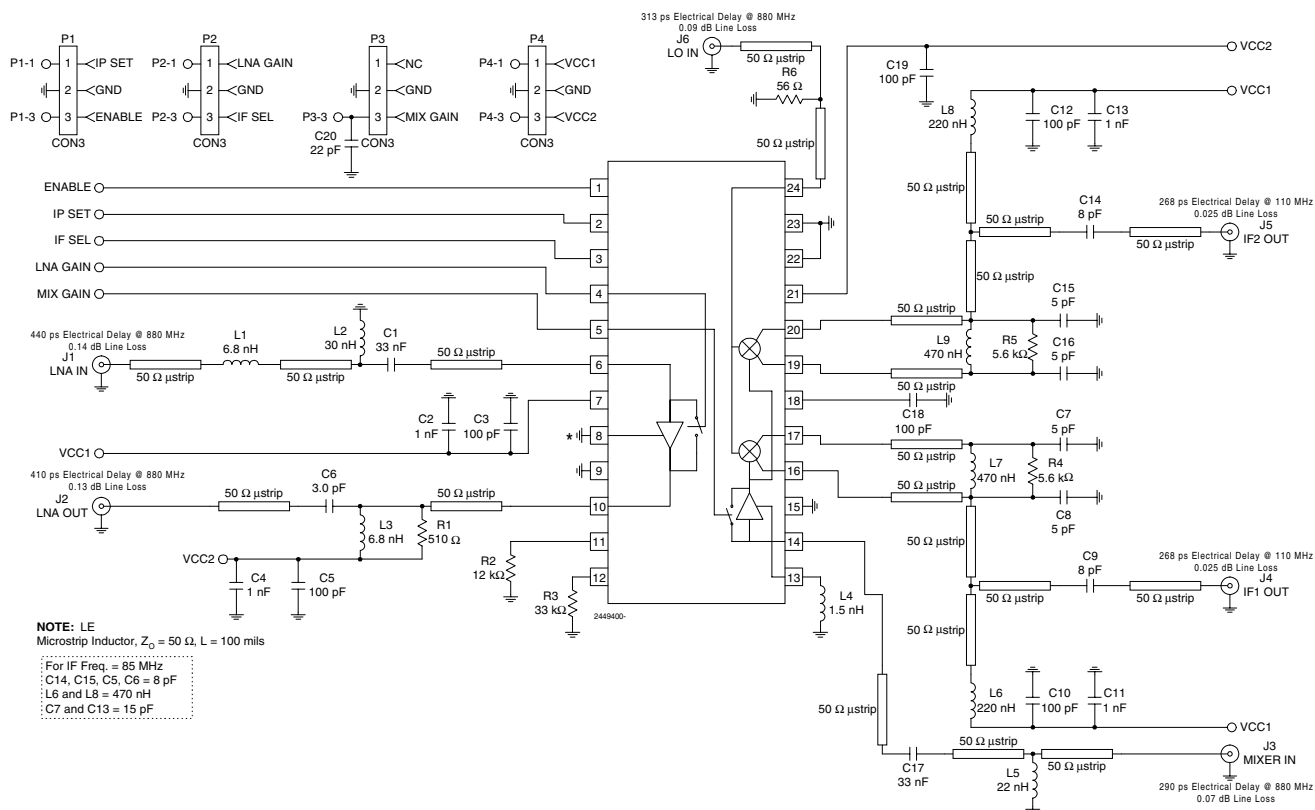
Parameter	Specification			Unit	Condition
	Min.	Typ.	Max.		
Overall					T = 25°C, V _{CC} =2.75V, RF=880MHz, LO=990MHz @ 0dBm, IF = 110MHz, V _{IPSET} <1.0V
RF Frequency Range		869 to 894		MHz	
LO Frequency Range		760 to 1010		MHz	
IF Frequency Range		0.1 to 250		MHz	
LNA - High Gain Mode					
Gain	14	15		dB	IIP3 is adjustable.
Noise Figure		2.3	2.5	dB	
IIP3		+6		dBm	
LNA Out to Mixer in Isolation		40		dB	
Current		3.5		mA	
LNA Bypass					
Gain		-6.3		dB	
Noise Figure		6.3		dB	
IIP3		20		dBm	
Current		0		mA	
Mixer - High Gain Mode					3kΩ balanced load.
Gain	12	13		dB	IIP3 is adjustable - See Data Plots.
Noise Figure		6.5	7.5	dB	
IIP3	+2	+3		dBm	
RF to IF Isolation	40			dB	
Current		21		mA	
Mixer - Low Gain Mode					3kΩ balanced load.
Gain	3	4		dB	IIP3 is adjustable - See Data Plots.
Noise Figure		13	14	dB	
IIP3	+12	+13		dBm	
RF to IF Isolation	40			dB	
Current		16		mA	
Local Oscillator Input					
Input Level	-10	-3	0	dBm	Any gain state.
LO to IF Isolation	36			dB	
LO to LNA Input Isolation	35			dB	
Cascade (Mode 1)					(LNA Gain High, Mix Gain High) With -3dB image rejection filter. 3kΩ balanced IF load. Single sideband.
Gain	24	25	27	dB	
Noise Figure		2.9		dB	
IIP3	-10	-9		dBm	
Cascade (Mode 2)					(LNA Gain High, Mix Gain Low) With -3dB image rejection filter. 3kΩ balanced IF load. Single sideband.
Gain		16.0		dB	
Noise Figure		4.7		dB	
IIP3		0		dBm	

Parameter	Specification			Unit	Condition
	Min.	Typ.	Max.		
Cascade (Mode 3)					(LNA Gain Low, Mix Gain High) With -3dB image rejection filter. 3k Ω balanced IF load. Single sideband.
Gain		3.5		dB	
Noise Figure		16		dB	
IIP3		+11.8		dBm	
Cascade (Mode 4)					(LNA Gain Low, Mix Gain Low) With -3dB image rejection filter. 3k Ω balanced IF load. Single sideband.
Gain		-5		dB	
Noise Figure		22.5		dB	
IIP3	+16.0	+18.0		dBm	
Power Supply					
Voltage	2.65	2.75	3.9	V	
Power Down Current			10	μ A	Enable<1.0V

Pin	Function	Description	Interface Schematic
1	ENABLE	This pin is used to enable or disable the RF2449. A logic high (>2.0V) enables the circuitry. A logic low (<1.0V) disables the circuitry.	ENABLE 
2	IP SET	Controls the setting of the LNA current. A logic low (<1.0V) selects the internal resistance (49.5kΩ), resulting in an LNA current of 3.5mA. A logic high (>2.0V) selects the external resistance at pin 12.	IP SET 
3	IF SEL	Determines which IF port is active. A logic low (<1.0V) activates IF1 and deactivates IF2. A logic high (>2.0V) activates IF2 and deactivates IF1.	IF SEL 
4	LNA GAIN	Controls the bypass feature of the LNA. A logic low (<1.0V) selects the bypass mode. A logic high (>2.0V) turns on the LNA.	LNA GAIN 
5	MIX GAIN	Controls the bypass feature of the mixer pre-amp. A logic low (<1.0V) selects the bypass mode. A logic high (>2.0V) turns on the pre-amp.	MIX GAIN 
6	LNA IN	LNA input pin.	
7	VCC1	VCC pin for all circuits except the LO.	
8	GND1B	LNA ground pin.	See pin 6.
9	GND1A	Package ground pin.	
10	LNA OUT	LNA output pin.	See pin 6.
11	ISET2	An external resistor connected to this pin sets the current of the pre-amp and the mixer.	
12	ISET1	An external resistor connected to this pin sets the current of the LNA when IP SET is high (see pin 2).	
13	GND3B	Ground pin for pre-amp circuit.	
14	MIX IN	Mixer pre-amp input pin.	See pin 13.
15	GND3A	Ground pin for the mixer circuits.	

Evaluation Board Schematic

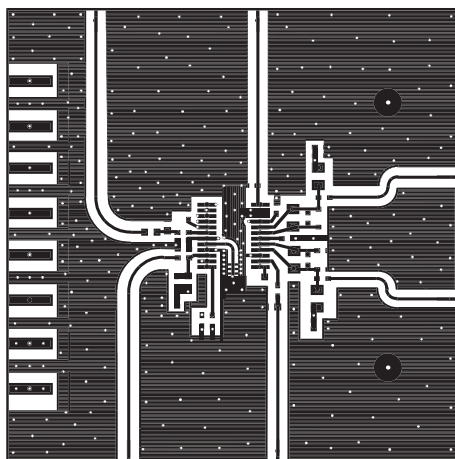
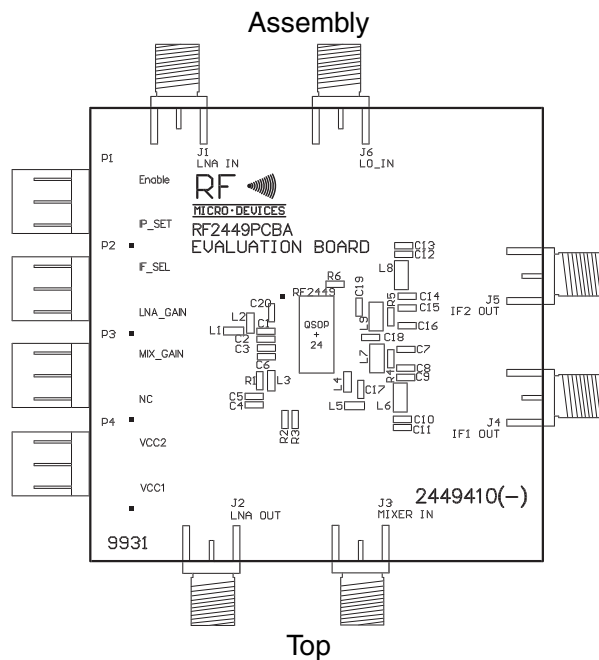
(Download [Bill of Materials](http://www.rfmd.com) from www.rfmd.com.)



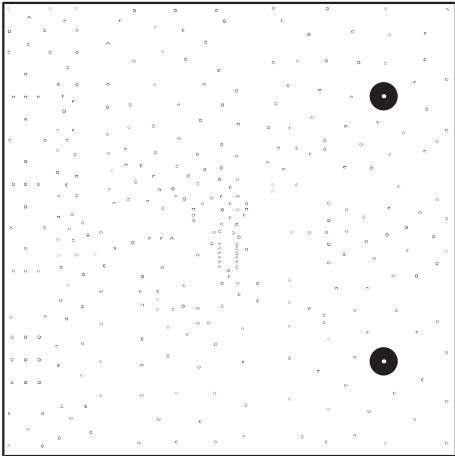
Evaluation Board Layout

Board Size 2.0" x 2.0"

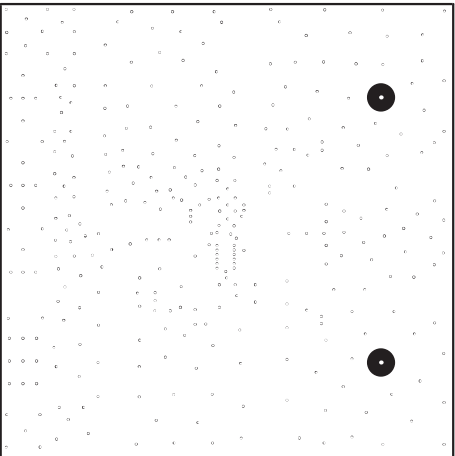
Board Thickness 0.040", Board Material FR-4, Multi-Layer



Inner 1



Inner 2



Back

